



**NTE2376
MOSFET
N-Ch, Enhancement Mode
High Speed Switch**

Features:

- Dynamic dv/dt Rating
- Repetitive Avalanche Rated
- Isolated Central Mounting Hole
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements

Absolute Maximum Ratings:

Continuous Drain Current ($V_{GS} = 10V$), I_D

$T_C = +25^\circ C$	30A
$T_C = +100^\circ C$	19A

Pulsed Drain Current (Note 1), I_{DM}

120A

Power Dissipation ($T_C = +25^\circ C$), P_D

190W

Derate Linearly Above $25^\circ C$

1.5W/ $^\circ C$

Gate-to-Source Voltage, V_{GS}

$\pm 20V$

Single Pulse Avalanche Energy (Note 2), E_{AS}

410mJ

Avalanche Current (Note 1), I_{AR}

30A

Repetitive Avalanche Energy (Note 1), E_{AR}

19mJ

Peak Diode Recovery dv/dt (Note 3), dv/dt

5V/ns

Operating Junction Temperature Range, T_J

-55° to $+150^\circ C$

Storage Temperature Range, T_{stg}

-55° to $+150^\circ C$

Lead Temperature (During Soldering, 1.6mm from case for 10sec), T_L

$+300^\circ C$

Mounting Torque (6-32 or M3 Screw)

10 lbf•in (1.1N•m)

Thermal Resistance, Junction-to-Case, R_{thJC}

0.65 $^\circ C/W$

Thermal Resistance, Junction-to-Ambient, R_{thJA}

40 $^\circ C/W$

Typical Thermal Resistance, Case-to-Sink (Flat, Greased Surface), R_{thCS}

0.24 $^\circ C/W$

Note 1. Repetitive rating; pulse width limited by maximum junction temperature.

Note 2. $V_{DD} = 50V$, starting $T_J = +25^\circ C$, $L = 683\mu H$, $R_G = 25\Omega$, $I_{AS} = 30A$

Note 3. $I_{SD} \leq 30A$, $di/dt \leq 190A/\mu s$, $V_{DD} \leq V_{(BR)DSS}$, $T_J \leq +150^\circ C$

Electrical Characteristics: ($T_J = +25^\circ\text{C}$ unless otherwise specified)

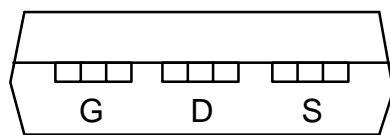
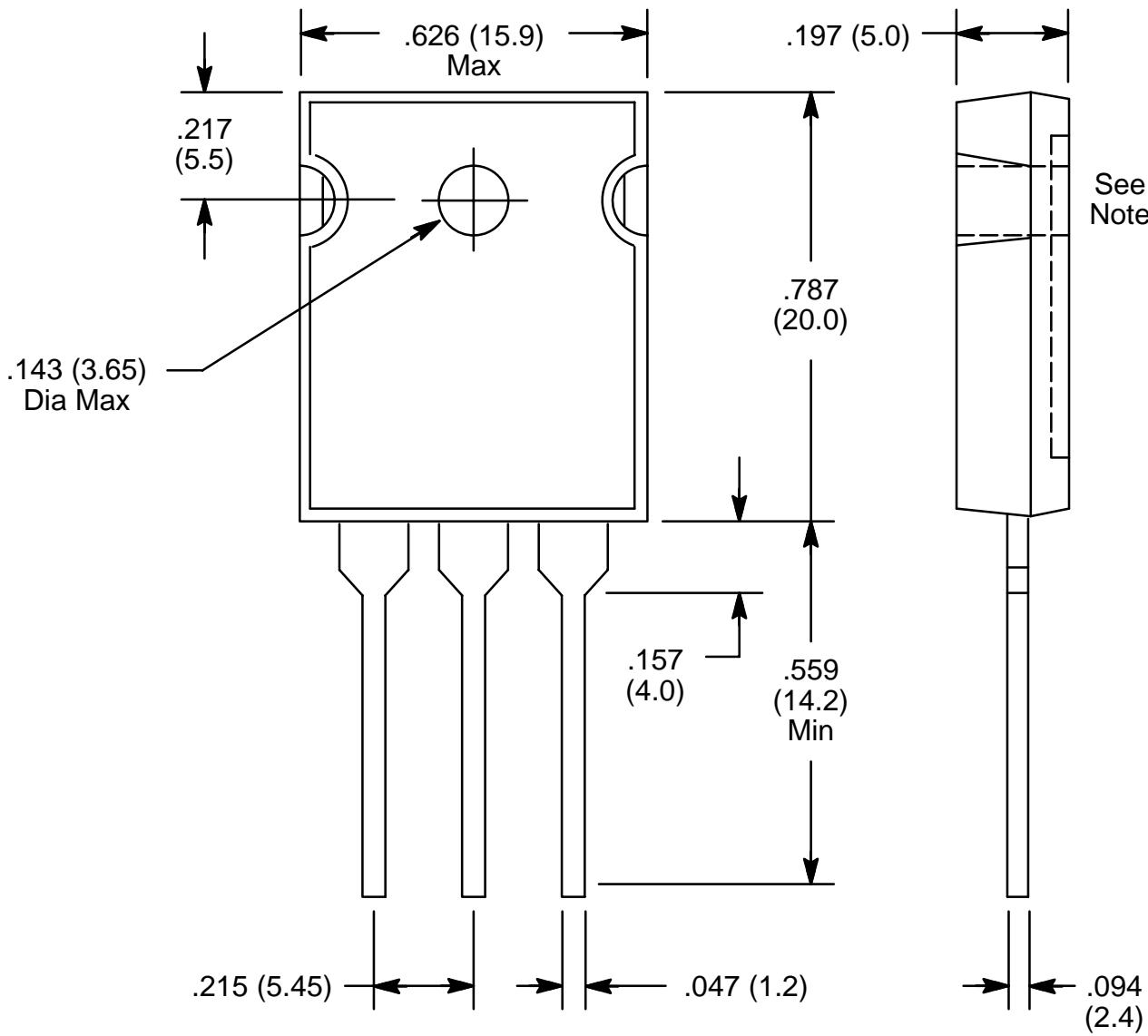
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-to-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0V, I_D = 250\mu\text{A}$	200	—	—	V
Breakdown Voltage Temp. Coefficient	$\frac{\Delta V_{(\text{BR})\text{DSS}}}{\Delta T_J}$	Reference to $+25^\circ\text{C}$, $I_D = 1\text{mA}$	—	0.27	—	$\text{V}/^\circ\text{C}$
Static Drain-to-Source On-Resistance	$R_{DS(\text{on})}$	$V_{GS} = 10V, I_D = 18\text{A}$, Note 4	—	—	0.085	Ω
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	2.0	—	4.0	V
Forward Transconductance	g_{fs}	$V_{DS} = 50V, I_D = 18\text{A}$, Note 4	12	—	—	mhos
Drain-to-Source Leakage Current	I_{DSS}	$V_{DS} = 200V, V_{GS} = 0V$	—	—	25	μA
		$V_{DS} = 160V, V_{GS} = 0V, T_J = +125^\circ\text{C}$	—	—	250	μA
Gate-to-Source Forward Leakage	I_{GSS}	$V_{GS} = 20V$	—	—	100	nA
Gate-to-Source Reverse Leakage	I_{GSS}	$V_{GS} = -20V$	—	—	-100	nA
Total Gate Charge	Q_g	$I_D = 30\text{A}, V_{DS} = 160V, V_{GS} = 10V$, Note 4	—	—	140	nC
Gate-to-Source Charge	Q_{gs}		—	—	28	nC
Gate-to-Drain ("Miller") Charge	Q_{gd}		—	—	74	nC
Turn-On Delay Time	$t_{d(\text{on})}$	$V_{DD} = 100V, I_D = 30\text{A}, R_G = 6.2\Omega, R_D = 3.2\Omega$, Note 4	—	16	—	ns
Rise Time	t_r		—	86	—	ns
Turn-Off Delay Time	$t_{d(\text{off})}$		—	70	—	ns
Fall Time	t_f		—	62	—	ns
Internal Drain Inductance	L_D	Between lead, .250in. (6.0) mm from package and center of die contact	—	5.0	—	nH
Internal Source Inductance	L_S		—	13.0	—	nH
Input Capacitance	C_{iss}	$V_{GS} = 0V, V_{DS} = 25V, f = 1\text{MHz}$	—	2800	—	pF
Output Capacitance	C_{oss}		—	780	—	pF
Reverse Transfer Capacitance	C_{rss}		—	250	—	pF

Source-Drain Ratings and Characteristics:

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Continuous Source Current (Body Diode)	I_S		—	—	30	A
Pulsed Source Current (Body Diode)	I_{SM}	Note 1	—	—	120	A
Diode Forward Voltage	V_{SD}	$T_J = +25^\circ\text{C}, I_S = 30\text{A}, V_{GS} = 0V$, Note 4	—	—	2.0	V
Reverse Recovery Time	t_{rr}	$T_J = +25^\circ\text{C}, I_F = 30\text{A}$, $di/dt = 100\text{A}/\mu\text{s}$, Note 4	—	360	540	ns
Reverse Recovery Charge	Q_{rr}		—	4.6	6.9	μC
Forward Turn-On Time	t_{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S+L_D)				

Note 1. Repetitive rating; pulse width limited by maximum junction temperature.

Note 4. Pulse width $\leq 300\mu\text{s}$; duty cycle $\leq 2\%$.



TO247

Note: Drain connected to metal part of mounting surface.